

BAS21SLT1

Preferred Device

Dual Series High Voltage Switching Diode

Features

- Moisture Sensitivity Level: 1
- ESD Rating – Human Body Model: Class 1
– Machine Model: Class B
- Pb-Free Package is Available

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---------------------------------|-----------------|-------|------|
| Continuous Reverse Voltage | V_R | 250 | Vdc |
| Repetitive Peak Reverse Voltage | V_{RRM} | 250 | Vdc |
| Peak Forward Current | I_F | 225 | mAdc |
| Peak Forward Surge Current | $I_{FM(surge)}$ | 625 | mAdc |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|-------------|----------------------|
| Total Device Dissipation FR-5 Board (Note 1) $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 225 | mW |
| | | 1.8 | mW/ $^\circ\text{C}$ |
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}$ | 556 | $^\circ\text{C/W}$ |
| Total Device Dissipation Alumina Substrate, (Note 2) $T_A = 25^\circ\text{C}$ Derate above 25°C | P_D | 300 | mW |
| | | 2.4 | mW/ $^\circ\text{C}$ |
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}$ | 417 | $^\circ\text{C/W}$ |
| Junction and Storage Temperature Range | T_J, T_{stg} | -55 to +150 | $^\circ\text{C}$ |

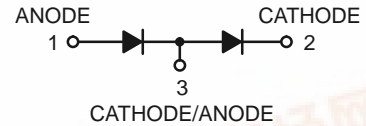
- FR-5 = $1.0 \times 0.75 \times 0.062$ in.
- Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

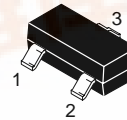


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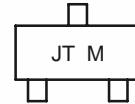
<http://onsemi.com>



MARKING DIAGRAM



SOT-23
CASE 318
STYLE 11



JT = Device Code
M = Date Code

ORDERING INFORMATION

| Device | Package | Shipping† |
|------------|------------------|------------------|
| BAS21SLT1 | SOT-23 | 3000/Tape & Reel |
| BAS21SLT1G | SOT-23 (Pb-Free) | 3000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

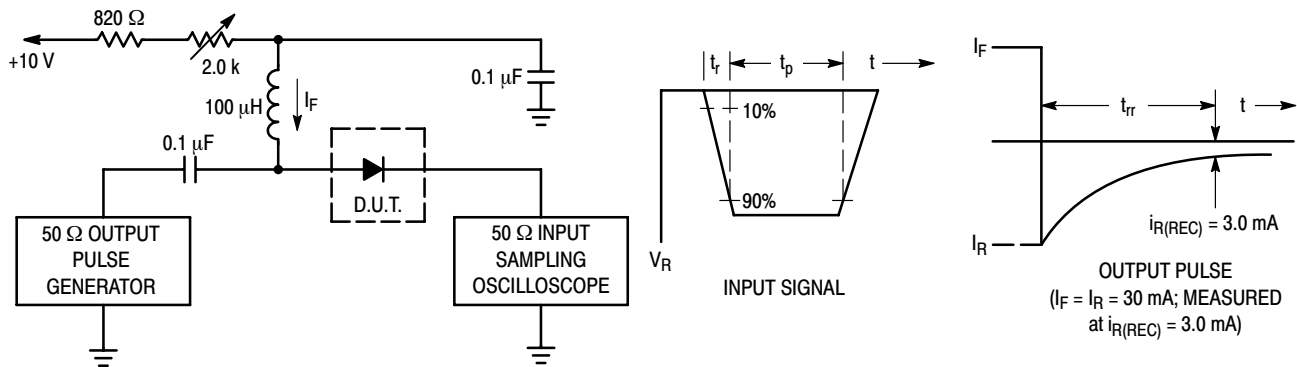
Preferred devices are recommended choices for future use and best overall value.



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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|------------|-----|--------------|-----------------|
| OFF CHARACTERISTICS | | | | |
| Reverse Voltage Leakage Current ($V_R = 200\text{ Vdc}$) ($V_R = 200\text{ Vdc}$, $T_J = 150^\circ\text{C}$) | I_R | - | 0.1 100 | μAdc |
| Reverse Breakdown Voltage ($I_{BR} = 100\ \mu\text{Adc}$) | $V_{(BR)}$ | 250 | - | Vdc |
| Forward Voltage ($I_F = 100\ \text{mA}$) ($I_F = 200\ \text{mA}$) | V_F | - | 1000 1250 | mV |
| Diode Capacitance ($V_R = 0$, $f = 1.0\ \text{MHz}$) | C_D | - | 5.0 | pF |
| Reverse Recovery Time ($I_F = I_R = 30\ \text{mA}$, $R_L = 100\ \Omega$) | t_{rr} | - | 50 | ns |



- Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 30 mA.
 2. Input pulse is adjusted so $I_{R(\text{peak})}$ is equal to 30 mA.
 3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

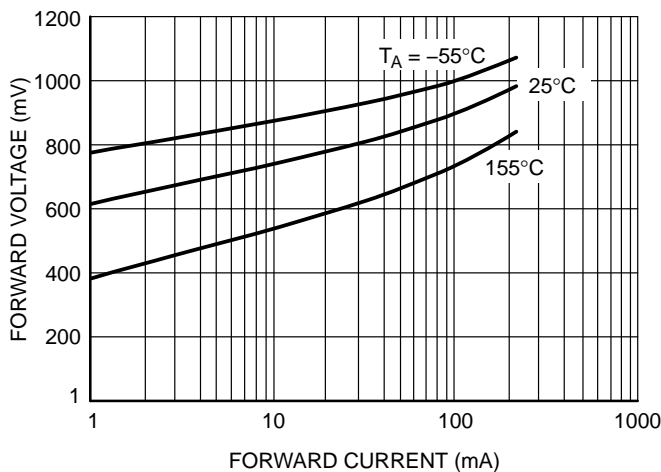


Figure 2. Forward Voltage

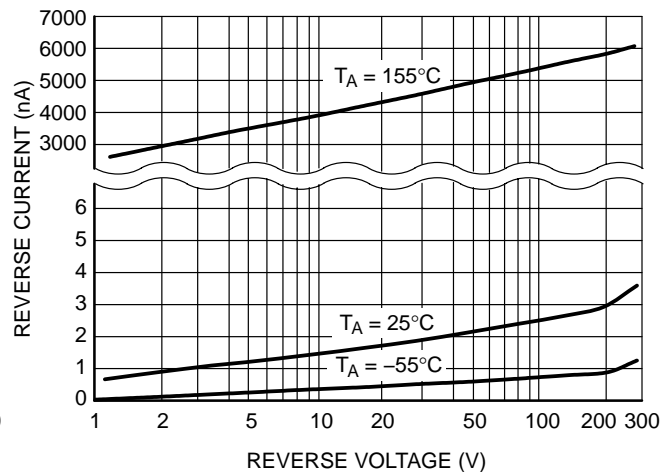
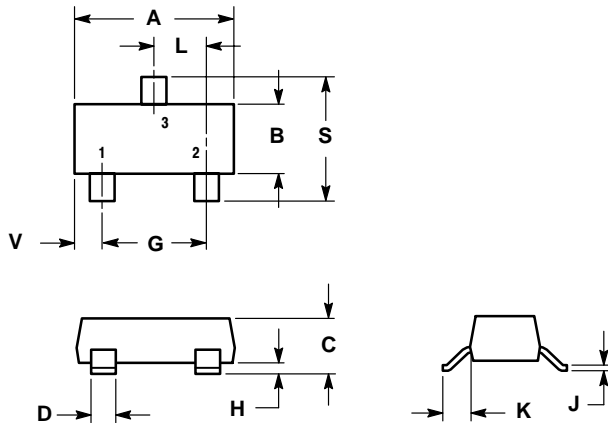


Figure 3. Reverse Leakage

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PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-09
ISSUE AH



NOTES:

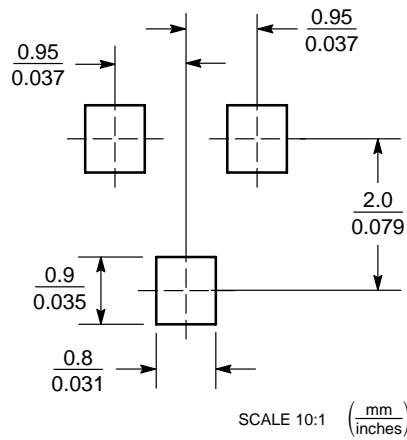
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01, -02, AND -06 OBSOLETE, NEW STANDARD 318-09.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|--------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.1102 | 0.1197 | 2.80 | 3.04 |
| B | 0.0472 | 0.0551 | 1.20 | 1.40 |
| C | 0.0385 | 0.0498 | 0.99 | 1.26 |
| D | 0.0140 | 0.0200 | 0.36 | 0.50 |
| G | 0.0670 | 0.0826 | 1.70 | 2.10 |
| H | 0.0040 | 0.0098 | 0.10 | 0.25 |
| J | 0.0034 | 0.0070 | 0.085 | 0.177 |
| K | 0.0180 | 0.0236 | 0.45 | 0.60 |
| L | 0.0350 | 0.0401 | 0.89 | 1.02 |
| S | 0.0830 | 0.0984 | 2.10 | 2.50 |
| V | 0.0177 | 0.0236 | 0.45 | 0.60 |

STYLE 11:


- PIN 1: ANODE
- CATHODE
- CATHODE-ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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